MOS FET Power Amplifier Module for E-GSM and DCS1800 Dual Band Handy Phone

HITACHI

ADE-208-821C (Z) 4th Edition Feb. 2001

Application

- Dual band Amplifier for E-GSM (880 MHz to 915 MHz) and DCS1800 (1710 MHz to 1785 MHz)
- For 3.5 V nominal battery use

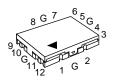
Features

- 2 in / 2 out dual band amplifire
- Simple external circuit including output matching circuit
- High gain 3stage amplifier: 0 dBm input Typ
- Lead less thin & Small package: $11 \times 13.75 \times 1.8$ mm Typ
- High efficiency: 50 % Typ at nominal output power for E-GSM

43 % Typ at 32.7 dBm for DCS1800

Pin Arrangement

• RF-O-12



- 1: N/C
- 2: N/C
- 3: Pout DCS
- 4: Vdd _{DCS}
- 5: Vdd _{GSM}
- 6: Pout GSM
- 7: N/C
- 8: Vtxlo
- 9: Pin GSM
- 10: Vapc GSM
- 11: Vapc DCS
- 12: Pin DCS
- G: GND



Absolute Maximum Ratings (Tc = 25°C)

Item	Symbol	Rating	Unit
Supply voltage	Vdd	8	V
Supply current	Idd _{GSM}	3	Α
	Idd _{DCS}	2	Α
Vtxlo voltage	Vtxlo	4	V
Vapc voltage	Vapc	4	V
Input power	Pin	10	dBm
Operating case temperature	Tc (op)	-30 to +100	°C
Storage temperature	Tstg	-30 to +100	°C
Output power	Pout GSM	5	W
	Pout DCS	3	W

Note: The maximum ratings shall be valid over both the E-GSM-band (880 MHz to 915 MHz), and the DCS1800-band (1710 MHz to 1785 MHz).

Electrical Characteristics for DC (Tc = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Drain cutoff current	lds	_	_	100	μΑ	Vdd = 8 V, Vapc = 0 V
Vapc control current	lapc	_	_	3	mA	Vapc =2.2 V
Vtxlo control current	Itxlo			100	μΑ	Vtxlo = 2.4 V

Electrical Characteristics for E-GSM mode (Tc = 25°C)

Test conditions unless otherwise noted:

f=880 to 915 MHz, Vdd $_{GSM}=3.5$ V, Pin $_{GSM}=0$ dBm, Rg = Rl = 50 Ω , Tc = 25°C, Vapc $_{DCS}=0.1$ V Pulse operation with pulse width 577 μs and duty cycle 1:8 shall be used.

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Frequency range	f	880	_	915	MHz	
Total efficiency (Hi)	$\eta_{T(Hi)}$	41	50		%	Pout _{GSM} = 35.5dBm, Vtxlo = 0.1V,
2nd harmonic distortion	2nd H.D.	_	-45	-38	dBc	Vapc _{GSM} = controlled
3rd harmonic distortion	3rd H.D.	_	-45	-40	dBc	-
Input VSWR	VSWR (in)		1.5	3	_	-
Total efficiency (Lo)	$\eta_{T(Lo)}$	27	35		%	Pout _{GSM} = 30.8dBm, Vtxlo = 2.4V, Vapc _{GSM} = controlled
Output power (1)(Hi)	Pout (1)(Hi)	35.5	36.0	_	dBm	Vapc _{GSM} = 2.2V, Vtxlo = 0.1V
Output power (1)(Lo)	Pout (1)(Lo)	30.8	31.3	_	dBm	Vapc _{GSM} = 2.2V, Vtxlo = 2.4V
Output power (2)(Hi)	Pout (2)(Hi)	33.5	34.0	_	dBm	$Vdd_{GSM} = 3.0V, Vapc_{GSM} = 2.2V,$ $Tc = +85^{\circ}C, Vtxlo = 0.1V$
Output power (2)(Lo)	Pout (2)(Lo)	28.8	29.3	_	dBm	$Vdd_{GSM} = 3.0V, Vapc_{GSM} = 2.2V,$ $Tc = +85^{\circ}C, Vtxlo = 2.4V$
Isolation	_	_	-42	-36	dBm	Vapc _{GSM} = 0.2V, Vtxlo = 0.1V
Isolation at DCS RF-output when GSM is active	<u></u>		-23	-17	dBm	Pout _{GSM} = 35.5dBm, Vtxlo = 0.1V Measured at f = 1760 to 1830MHz
Switching time	t _r , t _f		1	2	μs	Pout _{GSM} = 0 to 35.5dBm, Vtxlo = 0.1V
Stability		No parasitic oscillation			_	$\label{eq:decomposition} \begin{array}{l} \mbox{Vdd}_{\mbox{\sc GSM}} = 3.0 \mbox{\sc to} 5.1\mbox{\sc to}, \\ \mbox{Pout}_{\mbox{\sc GSM}} \leq 35.5\mbox{\sc dBm}, \mbox{\sc Vtxlo} = 0.1, 2.4\mbox{\sc V}, \\ \mbox{\sc Vapc}_{\mbox{\sc GSM}} \leq 2.2\mbox{\sc V}, \mbox{\sc GSMpulse}. \mbox{\sc Rg} = 50\Omega, \\ \mbox{\sc Output VSWR} = 6: 1 \mbox{\sc All phases} \end{array}$
Load VSWR tolerance		No degradation				$\label{eq:decomposition} \begin{array}{l} \mbox{Vdd}_{\mbox{\sc GSM}} = 3.0 \mbox{\sc to } 5.1\mbox{\sc V}, \ t = 20\mbox{\sc sc.}, \\ \mbox{Pout}_{\mbox{\sc GSM}} \le 35.5\mbox{\sc Bm}, \mbox{\sc Vtxlo} = 0.1, 2.4\mbox{\sc V}, \\ \mbox{\sc Vapc}_{\mbox{\sc GSM}} \le 2.2\mbox{\sc V}, \mbox{\sc GSM} \mbox{\sc pulse}. \mbox{\sc Rg} = 50\Omega, \\ \mbox{\sc Output VSWR} = 10: 1 \mbox{\sc All phases} \end{array}$

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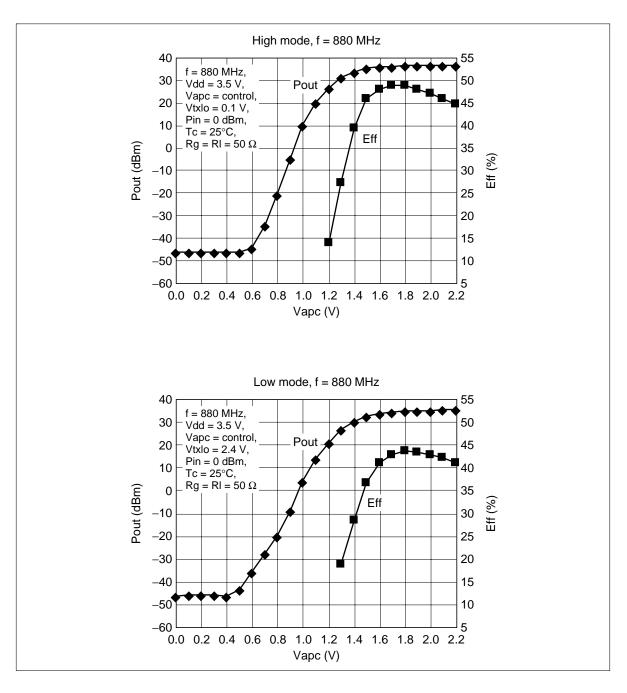
Electrical Characteristics for DCS1800 mode (Tc = 25°C)

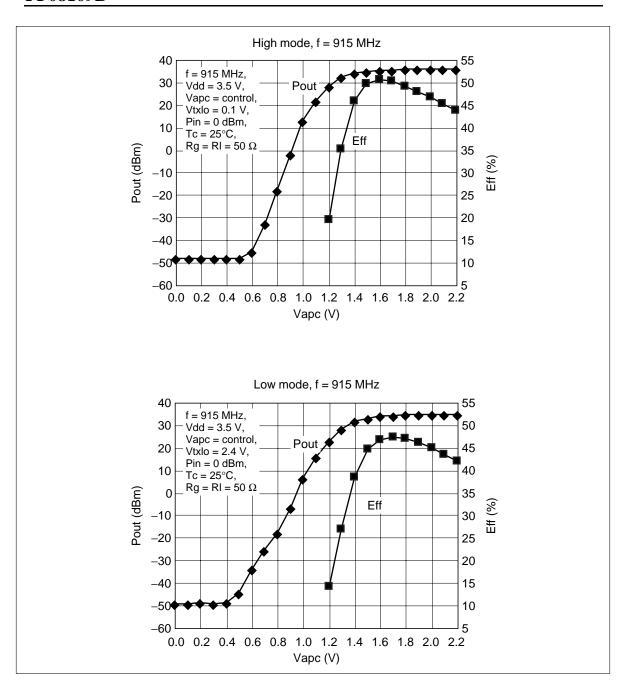
Test conditions unless otherwise noted:

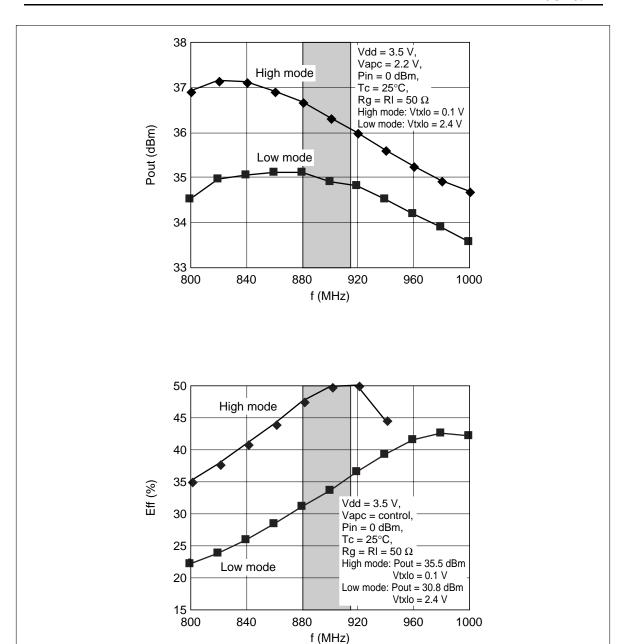
f=1710 to 1785 MHz, Vdd $_{DCS}=3.5$ V, Pin $_{DCS}=0$ dBm, $Rg=Rl=50~\Omega,$ $Tc=25^{\circ}C,$ Vapc $_{GSM}$ =0.1 V Pulse operation with pulse width 577 μs and duty cycle 1:8 shall be used.

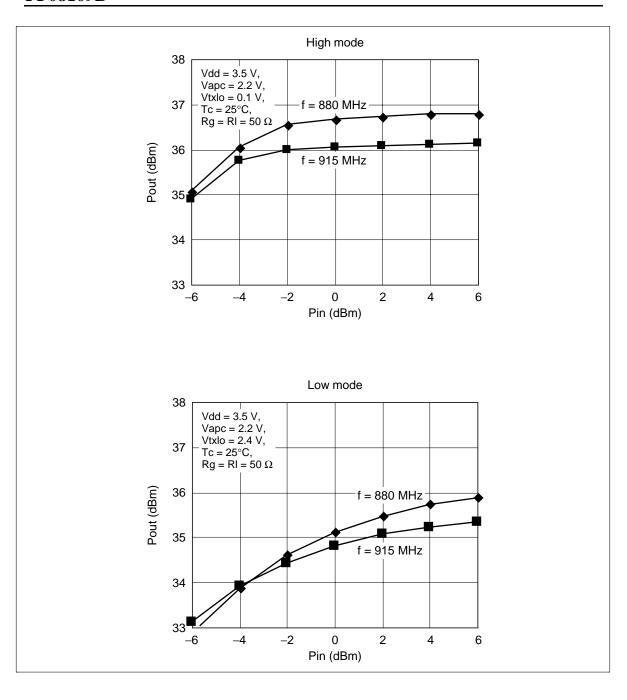
Item	Symbol	Min	Тур	Max	Unit	Test Condition
Frequency range	f	1710	_	1785	MHz	
Total efficiency (Hi)	$\eta_{T(Hi)}$	36	43	_	%	Pout _{DCS} = 32.7dBm,
2nd harmonic distortion	2nd H.D.	_	-45	-38	dBc	Vapc _{DCS} = controlled
3rd harmonic distortion	3rd H.D.	_	-45	-40	dBc	
Input VSWR	VSWR (in)	_	1.5	3	_	
Total efficiency (Lo)	$\eta_{T(Lo)}$	17	25	_	%	Pout _{DCS} = 26.7dBm, Vapc _{DCS} = controlled
Output power (1)	Pout (1)	32.7	33.2	_	dBm	Vapc _{DCS} = 2.2V,
Output power (2)	Pout (2)	30.7	31.2		dBm	Vdd $_{DCS}$ = 3.0V, Vapc $_{DCS}$ = 2.2V, Tc = +85°C
Isolation		_	-42	-36	dBm	Vapc _{DCS} = 0.2V
Isolation at GSM RF-output when DCS is active			-10	0	dBm	Pout _{DCS} = 32.7dBm, Measured at f = 1710 to 1785MHz
Switching time	t _r , t _f	_	1	2	μs	Pout _{DCS} = 0 to 32.7dBm
Stability	_	No parasitic oscillation —			_	Vdd $_{DCS}$ = 3.0 to 5.1V, Pout $_{DCS}$ \leq 32.7dBm, Vapc $_{DCS}$ \leq 2.2V, DCS pulse. Rg = 50Ω , Output VSWR = 6 : 1 All phases
Load VSWR tolerance	_	No degradation			_	$\begin{aligned} &\text{Vdd}_{\text{DCS}} = 3.0 \text{ to } 5.1\text{V}, \\ &\text{Pout}_{\text{DCS}} \leq 32.7\text{dBm, t} = 20\text{sec.,} \\ &\text{Vapc}_{\text{DCS}} \leq 2.2\text{V, DCS pulse. Rg} = 50\Omega, \\ &\text{Output VSWR} = 10:1 \text{ All phases} \end{aligned}$

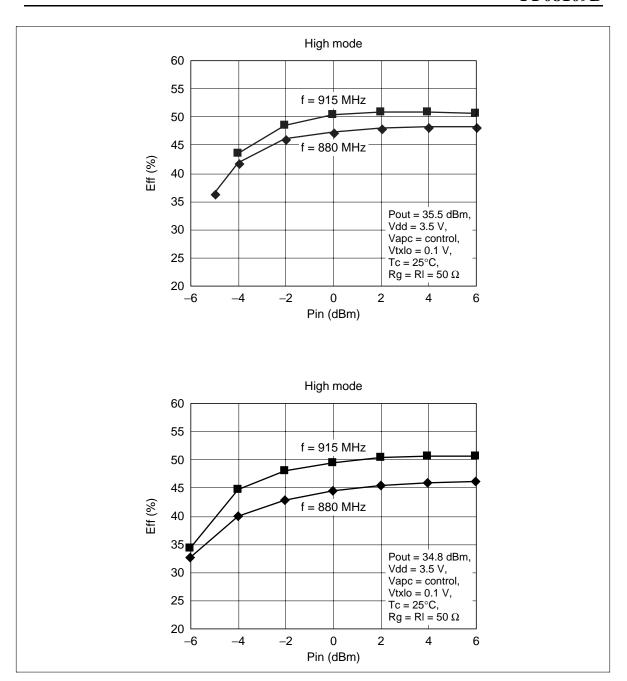
Characteristic Curves

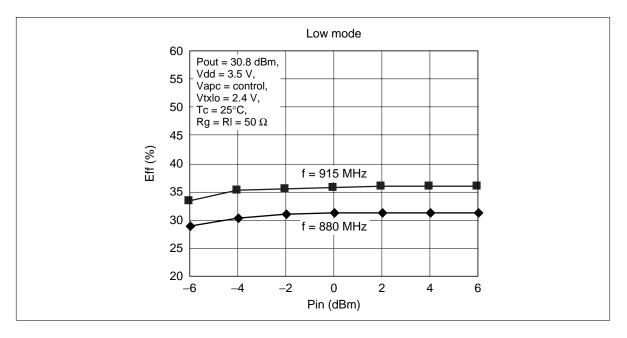


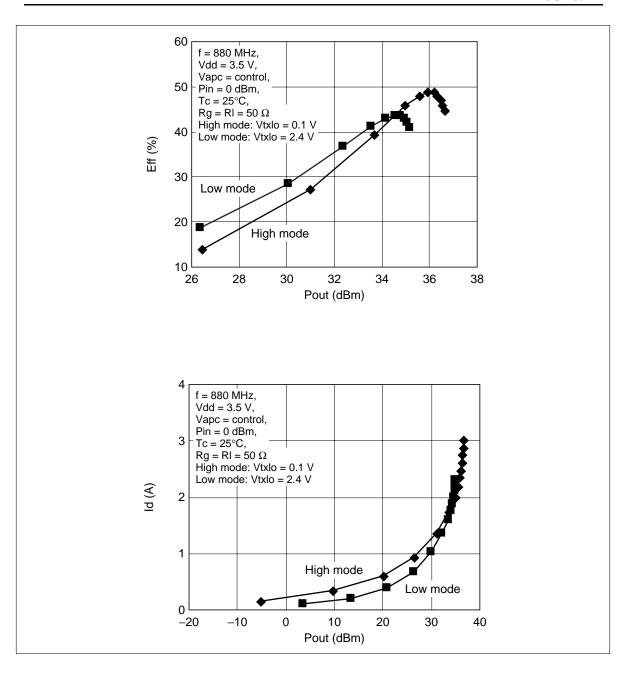


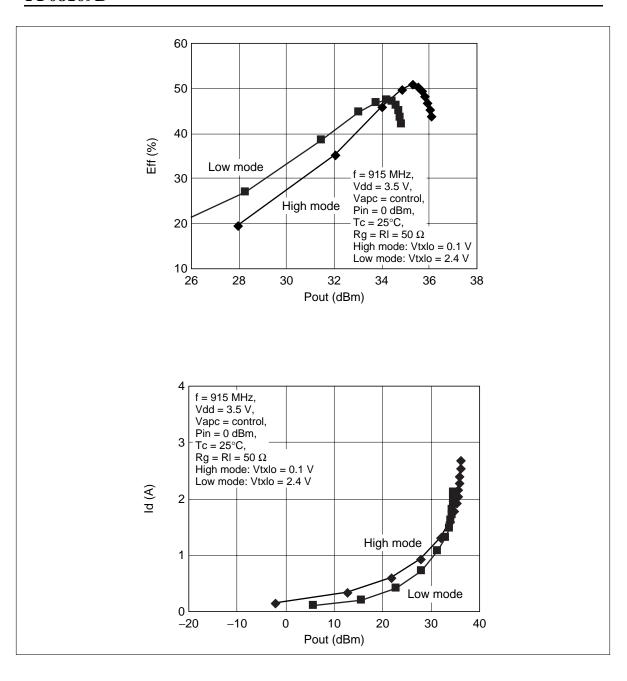


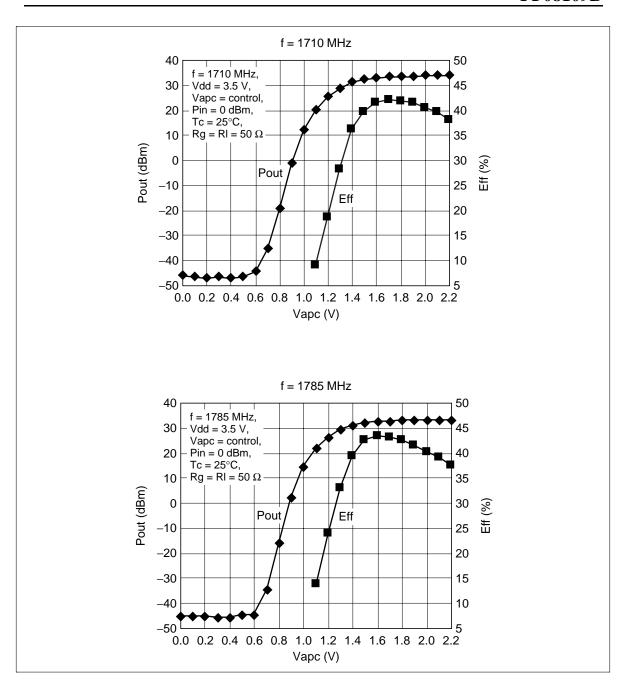


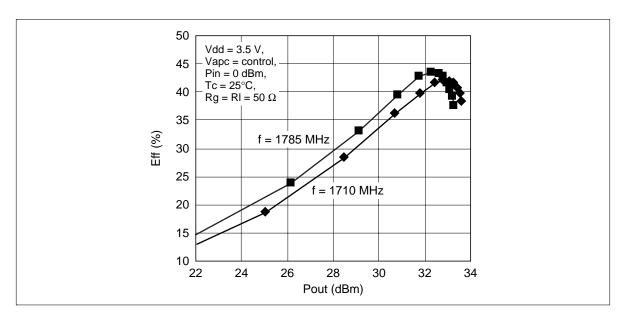


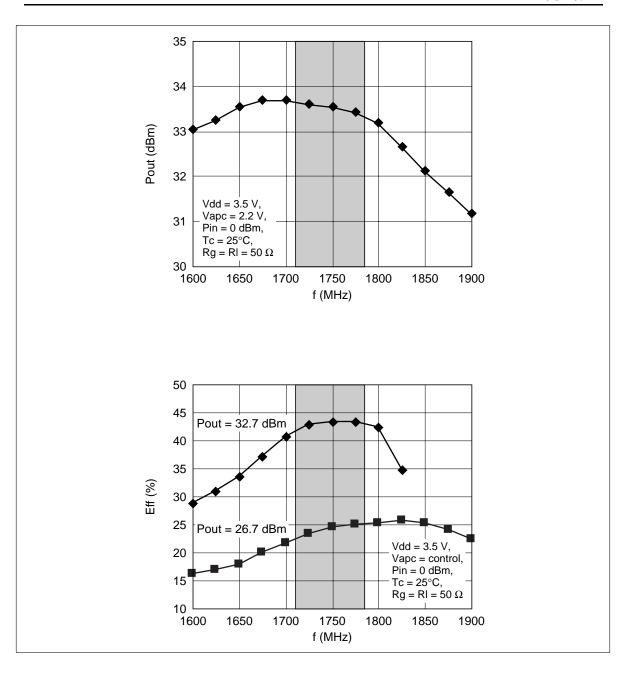


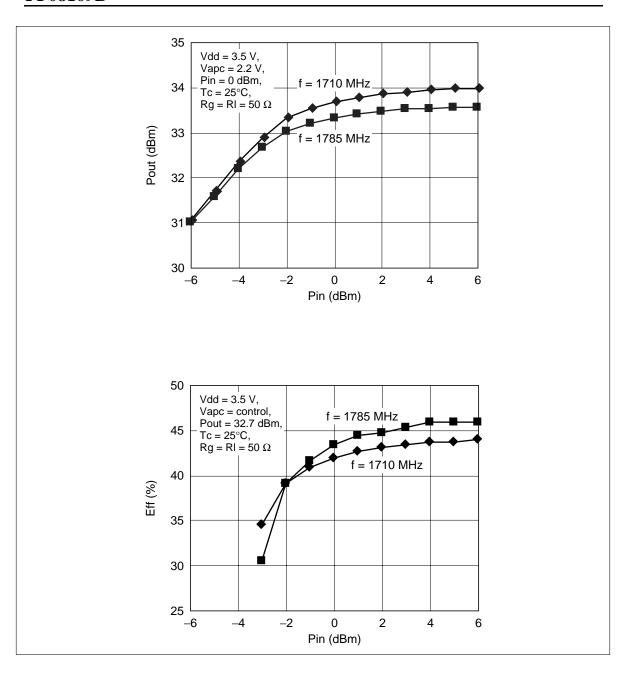


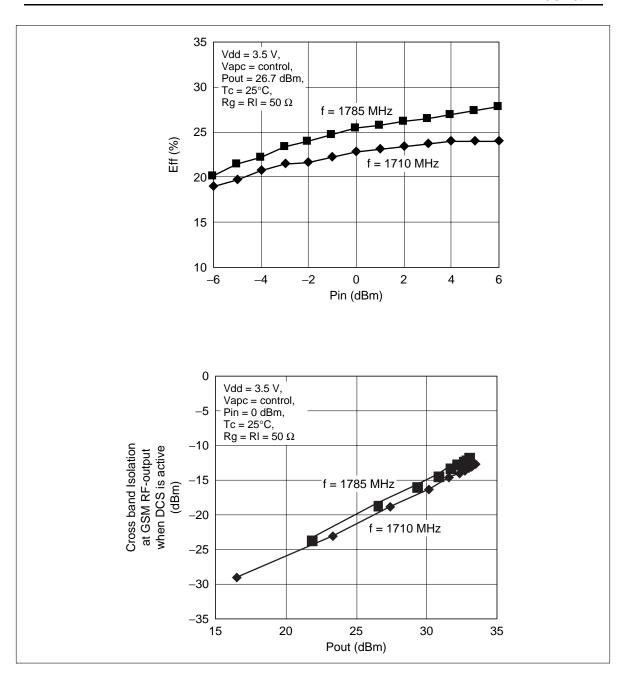


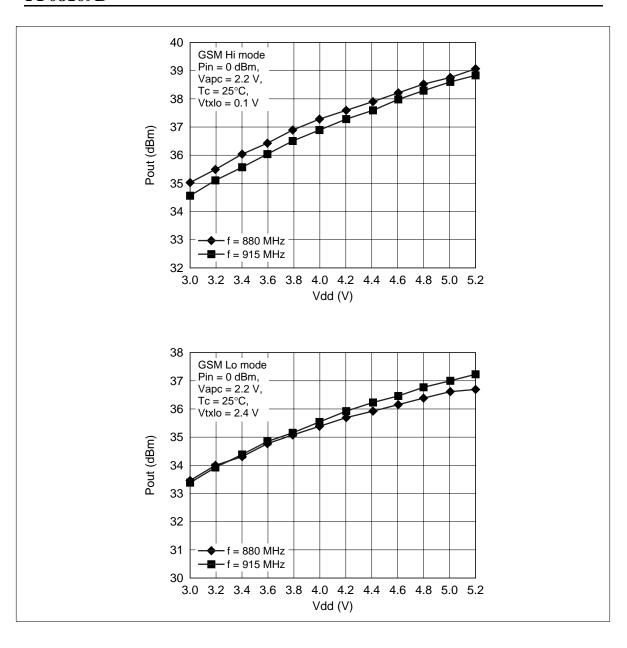


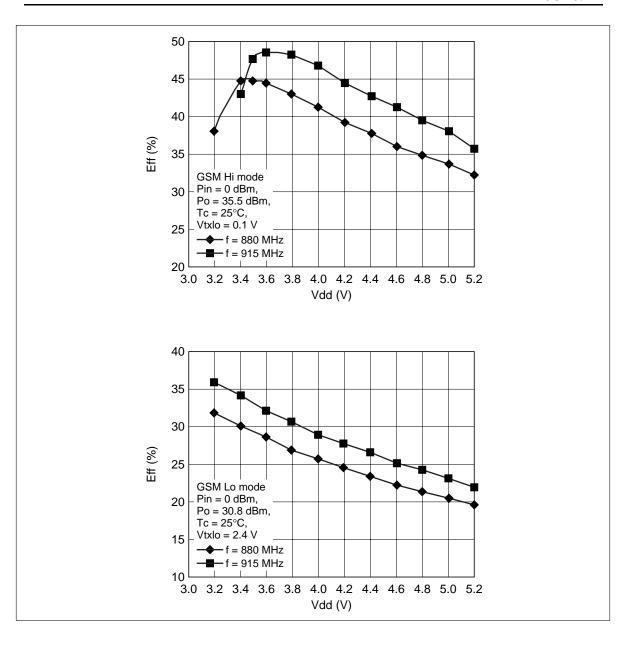


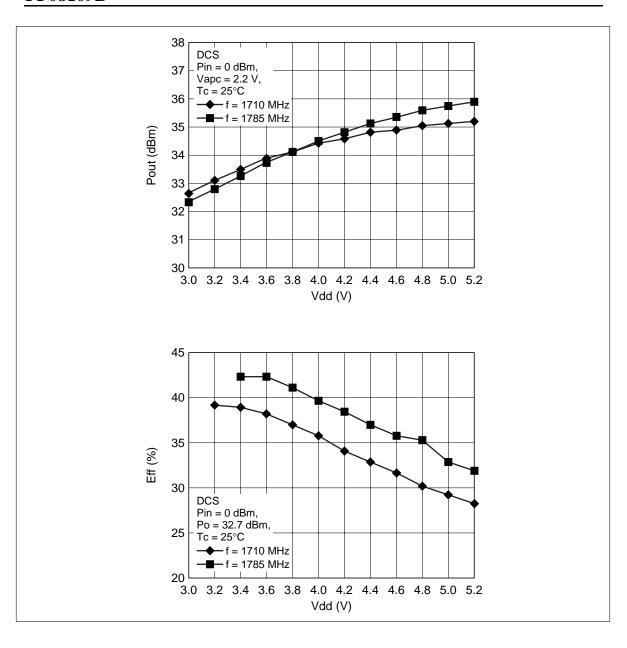


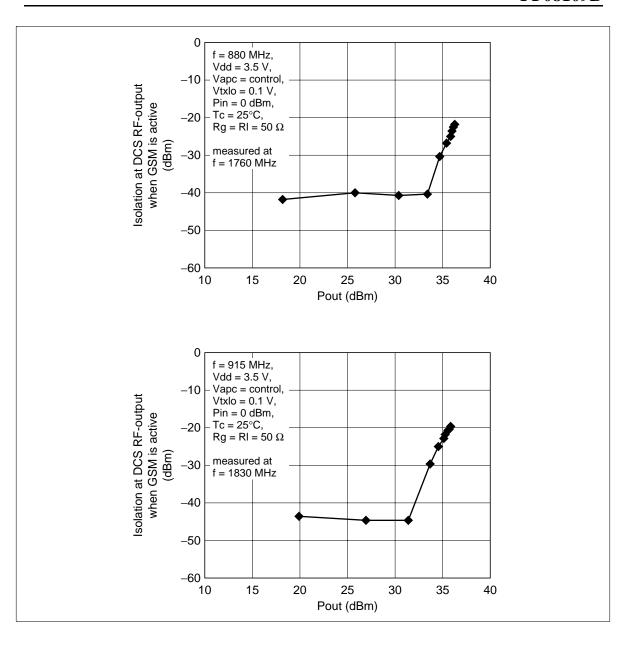




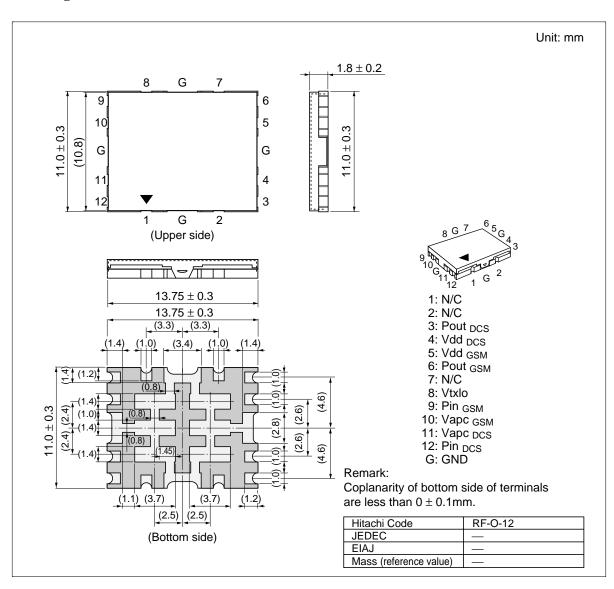








Package Dimensions



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